

RoHS

COMPLIANT

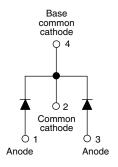
HALOGEN

FREE

Schottky Rectifier, 2 x 6 A



D-PAK (TO-252AA)



PRODUCT SUMMARY				
Package	D-PAK (TO-252AA)			
I _{F(AV)}	2 x 6 A			
V _R	60 V			
V _F at I _F	0.57 V			
I _{RM}	35 mA at 125 °C			
T _J max.	150 °C			
Diode variation	Common cathode			
E _{AS}	7 mJ			

FEATURES

- Low forward voltage drop
- Guard ring for enhanced ruggedness and long term reliability
- Popular D-PAK outline
- Center tap configuration
- · Small foot print, surface mountable
- High frequency operation
- AEC-Q101 qualified
- Meets JESD 201 class 2 whisker test
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: For definitions of compliance please see www.vishav.com/doc?99912



The VS-12CWQ06FNHM3 surface mount, center tap, Schottky rectifier series has been designed for applications requiring low forward drop and small foot prints on PC board. Typical applications are in disk drives, switching power supplies, converters, freewheeling diodes, battery charging, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I _{F(AV)}	Rectangular waveform	12	A			
V _{RRM}		60	V			
I _{FSM}	t _p = 5 µs sine	320	A			
V _F	6 A _{pk} , T _J = 125 °C (per leg)	0.57	V			
T_J	Range	- 55 to 150	°C			

VOLTAGE RATINGS					
PARAMETER SYMBOL VS-12CWQ06FNHM3 UNITS					
Maximum DC reverse voltage	V_{R}	60	V		
Maximum working peak reverse voltage	V_{RWM}	60 V			

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS		
Maximum average per leg	_	50 % duty cycle at T _C = 131 °C, rectangular waveform		6	А		
See fig. 5 per device	I _{F(AV)}			12			
Maximum peak one cycle non-repetitive surge current		5 μs sine or 3 μs rect. pulse Following any rated		320	A		
See fig. 7	I_{FSM} load condition and with rated V_{RRM} applied		105	^			
Non-repetitive avalanche energy per leg	E _{AS}	T _J = 25 °C, I _{AS} = 1.2 A, L = 10 mH		7	mJ		
I Benefitive avalanche current per led I IAB I		Current decaying linearly to zero Frequency limited by T _J maximum	-	0.8	А		

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ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CO	VALUES	UNITS		
		6 A	T _{.1} = 25 °C	0.61	V	
Maximum forward	V _{FM} ⁽¹⁾	12 A	11=25 0	0.79		
voltage drop per leg See fig. 1	VFM ('')	6 A	T _{.1} = 125 °C	0.57		
		12 A	1J = 125 C	0.72		
Maximum reverse leakage current per leg	I _{RM} ⁽¹⁾	T _J = 25 °C	•		A	
See fig. 2	'RM '''	T _J = 125 °C	V _R = Rated V _R	35	- mA	
Threshold voltage	V _{F(TO)}	$T_{.1} = T_{.1}$ maximum		0.36	V	
Forward slope resistance	r _t	ıj=ıjınaxımum	24.14	mΩ		
Typical junction capacitance per leg	C _T	V _R = 5 V _{DC} , (test signal ran	360	pF		
Typical series inductance per leg	L _S	Measured lead to lead 5 m	nm from package body	5.0	nH	

Note

 $^{^{(1)}\,}$ Pulse width < 300 µs, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature range		T _J ⁽¹⁾ , T _{Stg}		- 55 to 150	°C	
Maximum thermal resistance,	per leg	D	DC operation	3.0	°C/W	
junction to case	per device	R_{thJC}	See fig. 4	1.5	C/VV	
Annuavimenta waisht				0.3	g	
Approximate weight				0.01	OZ.	
Marking device			Case style D-PAK	12CWC	06FNH	

Note

$$^{(1)} \quad \frac{dP_{tot}}{dT_J} < \frac{1}{R_{thJA}} \quad \text{thermal runaway condition for a diode on its own heatsink}$$

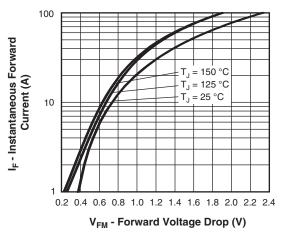


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

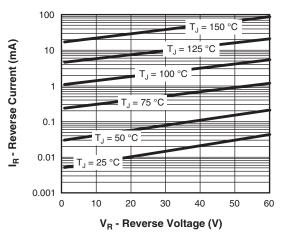


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

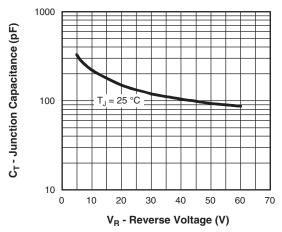


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

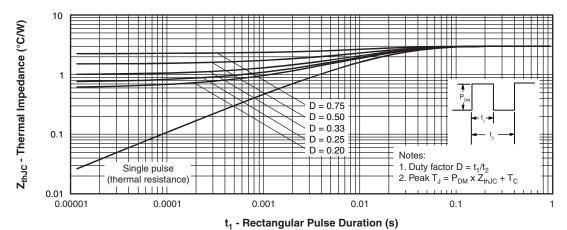


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)

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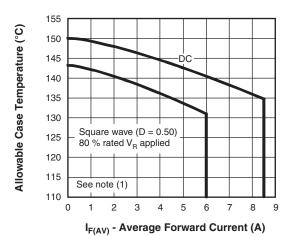


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

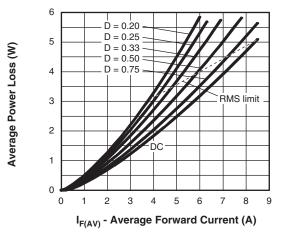


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

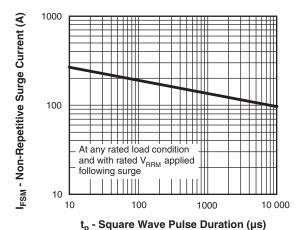


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

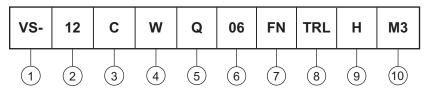
Note

 $\begin{array}{ll} \mbox{(1)} & \mbox{Formula used: } T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}; \\ Pd = \mbox{Forward power loss} = I_{F(AV)} \times V_{FM} \mbox{ at } (I_{F(AV)}/D) \mbox{ (see fig. 6);} \\ Pd_{REV} = \mbox{Inverse power loss} = V_{R1} \times I_R \mbox{ (1 - D); } I_R \mbox{ at } V_{R1} = 80 \mbox{ \% rated } V_R \\ \end{array}$



ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating (12 A)

Center tap configuration

Package identifier:

W = D-PAK

5 - Schottky "Q" series

Voltage rating (06 = 60 V)

7 - FN = TO-252AA

8 - • None = Tube

• TR = Tape and reel

• TRL = Tape and reel (left oriented)

• TRR = Tape and reel (right oriented)

9 - H = AEC-Q101 qualified

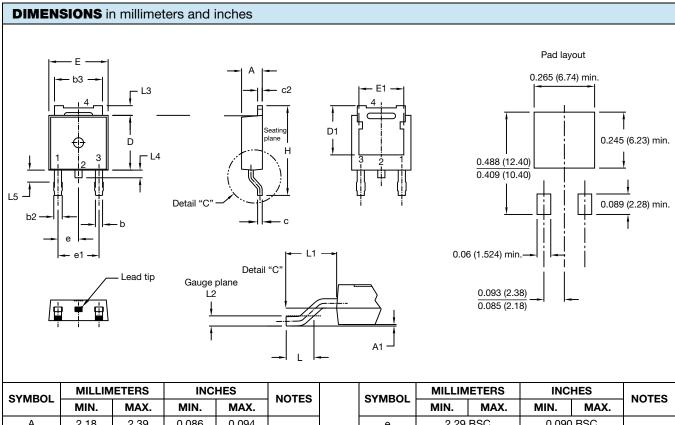
10 - Environmental digit:

M3 = Halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-12CWQ06FNHM3	75	3000	Antistatic plastic tube			
VS-12CWQ06FNTRHM3	2000	2000	13" diameter reel			
VS-12CWQ06FNTRRHM3	3000	3000	13" diameter reel			
VS-12CWQ06FNTRLHM3	3000	3000	13" diameter reel			

LINKS TO RELATED DOCUMENTS				
Dimensions <u>www.vishay.com/doc?95519</u>				
Part marking information	www.vishay.com/doc?95518			
Packaging information	www.vishay.com/doc?95033			

DPAK (TO-252AA)



SYMBOL	MILLIM	IETERS	INC	HES	NOTES
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	2.18	2.39	0.086	0.094	
A1	-	0.13	-	0.005	
b	0.64	0.89	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	3
С	0.46	0.61	0.018	0.024	
c2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	5
D1	5.21	-	0.205	-	3
Е	6.35	6.73	0.250	0.265	5
E1	4.32	-	0.170	-	3

SYMBOL	IVIILLIIV	IEIENO	INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	NOTES
е	2.29 BSC		SC 0.090 BSC		
Н	9.40	10.41	0.370	0.410	
L	1.40	1.78	0.055	0.070	
L1	2.74 BSC		0.108 REF.		
L2	0.51	0.51 BSC		BSC	
L3	0.89	1.27	0.035	0.050	3
L4	1	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	2

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension uncontrolled in L5
- (3) Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad
- (4) Dimensions D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (5) Outline conforms to JEDEC® outline TO-252AA

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